



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the Matter of the Application of: Frisch, et al.

Serial No.: 10/692,543 Confirmation No.: 1110

Filed: October 24, 2003

For: **Integrated Circuit System With A Latent Heat Storage Module**

Examiner: Unassigned Group Art Unit: Unassigned

Attorney Docket No.: 21334-1264

Mail Stop Missing Parts
Commissioner for Patents
P.O. Box 1450
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I hereby certify that this correspondence is being deposited with the United States Postal Service as first-class mail addressed to Mail Stop Missing Parts, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on April 6, 2004.




Heather L. Gonsorick

**INFORMATION DISCLOSURE
STATEMENT TRANSMITTAL LETTER**

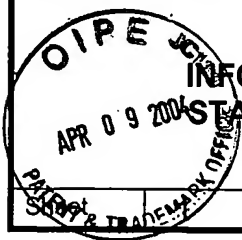
Sir:

An Information Disclosure Statement is submitted herewith pursuant to 37 CFR §§1.97-1.98. The enclosed statement is being filed within three months of the filing date of a national application, or within three months of the date of entry into the national stage as set forth in 37 CFR §1.491 in an international application, or before the mailing date of a first Office Action on the merits, whichever event occurs last.

Respectfully submitted,



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**INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**
Complete if Known

Application Number	10/692,543
Filing Date	October 24, 2003
First Named Inventor	Frisch, et al.
Group Art Unit	Unknown
Examiner Name	Unknown
Attorney Docket Number	21334-1264

of 1

U. S. PATENT DOCUMENTS

Examiner Initials		Document Number	Date	Name	Class	Sub-Class	Filing Date
	AA	6,269,866 B1	08/07/2001	Yamamoto, et al.			
	AB	2002/0033247 A1	03/21/2002	Neuschutz, et al.			
	AC						
	AD						
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	AL						
	AM						
	AN						
	AO						
	AP						
	AQ						
	AR						

FOREIGN PATENT DOCUMENTS

Examiner Initials		Document Number	Date	Country	Class	Sub-Class	TRNS Y/N
	AS	93 13 483.5 U1	01/05/1994	DE			
	AT						
	AU						
	AV						
	AW						

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

	AX	"Liquid Piston With Phase Change To Absorb Thermal Transients" IBM Technical Disclosure Bulletin, IBM Corporation, New York, U.S., Vol. 38, No. 10 (October 1995).
	AY	"Bayerer, et al., "Leistungshalbleitermodule In Direkt-Bonding-Technik" 1155 Technische Rundschau, Vol. 80, No. 32 (August 5, 1988).
	AZ	

Examiner Signature		Date Considered	
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EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.